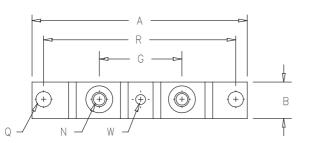
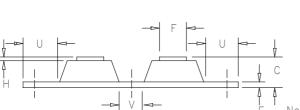
Schottky PowerMod









Baseplate



Notes: Baseplate: Nickel plated copper

Dim. Ir	iches	Millimeters		
Min.	Max.	Min.	Max.	Notes
Α	3.630		92.20	
B 0.700	0.800	17.78	20.32	
C	0.630		16.00	
	0.130	3.05	3.30	
F 0.490	0.510	12.45	12.95	
G 1.375	BSC	34.92 BSC		
H 0.010		0.25		
N				1/4-20
Q 0.275	0.290	6.99	7.37	Dia.
R 3.150	D BSC	80.01 BSC		
U 0.600		15.24		
V 0.312	0.340	7.92	8.64	
W 0.180	0.195	4.57	4.95	Dia.

Microsemi	Industry		Repetitive Peak
Catalog Number	Part Number		Reverse Voltage
CPT40130*	MBR40030CT	30V	30V
CPT40135*	400CNQ035	35V	35V
CPT40140*	400CNQ040	40V	40V
CPT40145*	400CNQ045 MBRP40045CTL	45V	45V

*Add Suffix A for Common Anode, D for Doubler

- Schottky Barrier Rectifier
- Guard Ring Protection
- 400 Amperes/30 to 45 Volts
- 150°C Junction Temperature
- Reverse Energy Tested
- ROHS Compliant

Electrical Characteristics

Average forward current per pkg Average forward current per leg Maximum surge current per leg Maximum surge current per leg | R(OV) 2 Amps |
Maximum repetitive reverse current per leg | R(OV) 2 Amps |
Max peak forward voltage per leg | VFM | 0.57 Volts Max peak forward voltage per leg Max peak reverse current per leg Max peak reverse current per leg Typical junction capacitance per leg

F(AV) 400 Amps |F(AV) 200 Amps FSM 3000 Amps 0.49 Volts VFM ^IRM 3.5 A ^IRM 10 mA C_{J} 7000 pF

 ^{T}C = 79°C, Square wave, $^{R}\Theta$ JC = 0.16°C/W ^{T}C = 79°C, Square wave, $^{R}\Theta$ JC = 0.32°C/W 8.3ms, half sine, $T_J = 150^{\circ}C$ f=1 KHZ, 25°C, 1 μ sec square wave f=1 KHZ, 25°C, 1 μ sec square wave

|FM = 200A:TJ = 150°C* |VRRM,TJ = 125°C* VRRM, TJ = 25°C* $V_R = 5.0V, T_C = 25^{\circ}C$

*Pulse test: Pulse width 300µsec, Duty cycle 2%

Thermal and Mechanical Characteristics

Storage temp range Operating junction temp range Max thermal resistance per leg Max thermal resistance per pkg Typical thermal resistance (greased) Terminal Torque Mounting Base Torque (outside holes) Mounting Base Torque (center hole) center hole must be torqued first Weight

TSTG ΤJ R OJC R OJC Recs -55°C to 150°C -55°C to 150°C

0.32°C/W Junction to case 0.16°C/W Junction to case 0.08°C/W Case to sink 35-40 inch pounds maximum 30-40 inch pounds maximum 8-10 inch pounds maximum

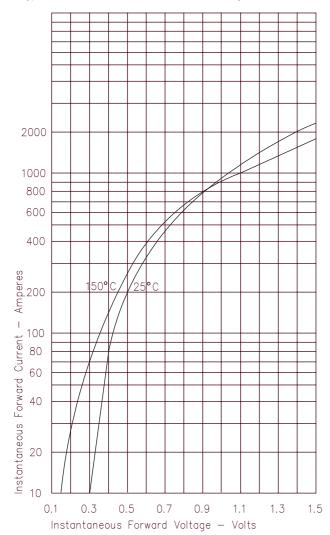
2.8 ounces (77 grams) typical



CPT40130 - CPT40145

Figure 3

Figure 1 Typical Forward Characteristics — Per Leg



Typical Junction Capacitance — Per Leg 100,000 60,000 40,000 20,000 Capacitance 10,000 6000 4000 Junction 2000 1000 5.0 0.5 10 50 0.1 1.0 100 Reverse Voltage - Volts

Figure 4

Forward Current Derating — Per Leg



Figure 2 Typical Reverse Characteristics — Per Leg

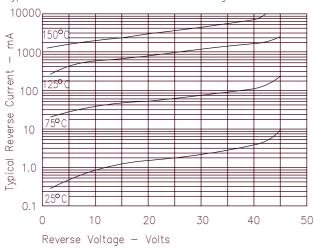
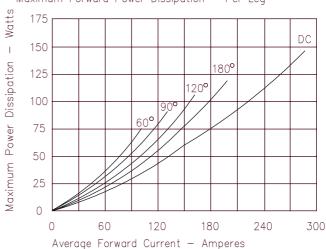


Figure 5
Maximum Forward Power Dissipation — Per Leg





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